

N-Channel 800 V (D-S) Super Junction Power MOSFET

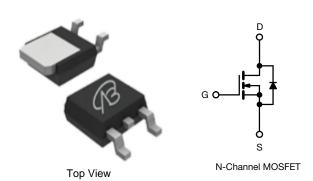
PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	800				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	1.0			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)







APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	800	V	
Gate-source voltage			V_{GS}	± 30	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Continuous drain current (T _J = 150 °C)	V_{GS} at 10 V T_{C}	T _C = 25 °C	- I _D	5		
		T _C = 100 °C		3	А	
Pulsed drain current ^a			I _{DM}	15		
Linear derating factor				1.7	W/°C	
Single pulse avalanche energy b			E _{AS}	380	mJ	
Maximum power dissipation			P_{D}	180	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		d\//d+	50	1//20	
Reverse diode dV/dt ^d			dV/dt	5.1	V/ns	
Soldering recommendations (peak temperature) c	c For 10 s			260	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 100 V, starting T_J = 25 °C, L = 30 mH, R_g = 25 Ω , I_{AS} = 2A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \ ^{\circ}\text{C}$

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W		
Maximum junction-to-case (drain)	R_{thJC}	-	0.85	C/ VV		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-				•	
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		1.08	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		-	4.0	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μΑ
		V _{DS} = 800 V, V _{GS} = 0 V		-	-	1	μА
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 \	V _{DS} = 640 V, V _{GS} = 0 V, T _J = 125 °C V _{GS} = 10 V I _D = 1.5A		-	10	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D =1.5A	-	1.0	-	Ω
Forward transconductance	9 _{fs}	V_{DS}	= 30 V, I _D = 5 A	-	8.7	-	S
Dynamic		•		ı	•	1	
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	900	-	
Output capacitance	C _{oss}	1	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		51	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		_	12	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	56	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	205	-	
Total gate charge	Qg			-	25	-	1
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 5 \text{ A}, V_{DS} = 480 \text{ V}$		8	-	nC
Gate-drain charge	Q _{gd}				10	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 480 V, I _D = 5 A,		-	12	24	
Rise time	t _r			-	14	23	
Turn-off delay time	t _{d(off)}	V _{GS}	$= 10 \text{ V}, R_a = 9.1 \Omega$	_	61	110	ns
Fall time	t _f		go a , g		16	-	1
Gate input resistance	R_g	f = 1	f = 1 MHz, open drain		0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s	-				•	
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5	
Pulsed diode forward current	I _{SM}			-	-	15	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 5 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	80	-	ns
Reverse recovery charge	Q _{rr}			_	6.4	12.8	μC
Reverse recovery current	I _{RRM}			_	27	-	A

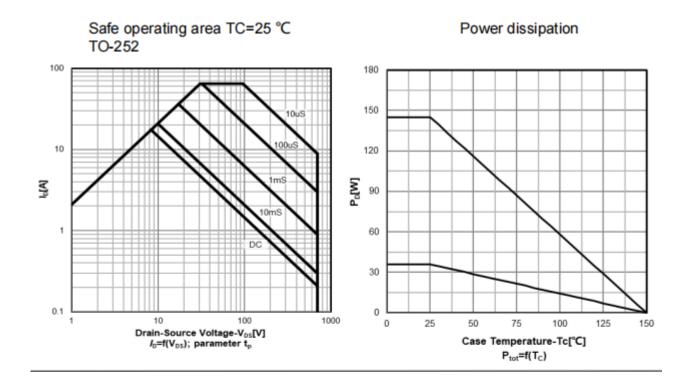
Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

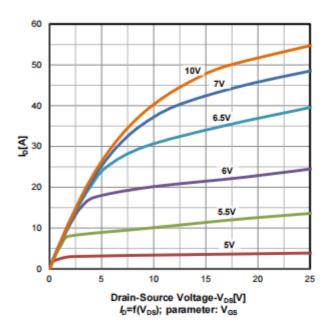
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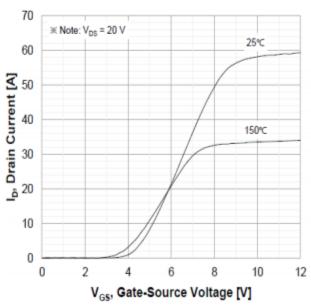
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Typ. output characteristics T_i =25 $^{\circ}C$



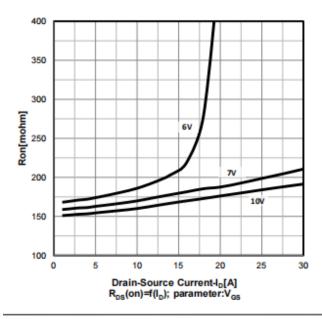
Transfer characteristics



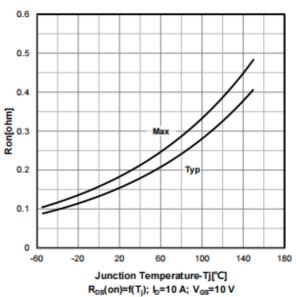
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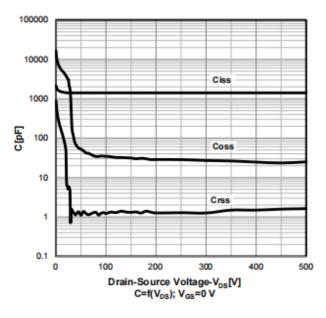
Typ. drain-source on-state resistance



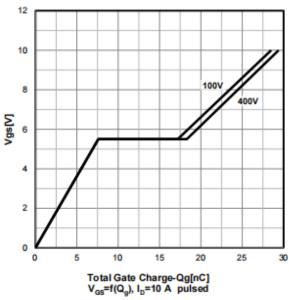
On-resistance vs temperature



Typ. capacitances



Typ. gate charge characteristics

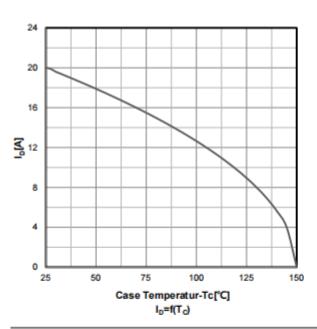


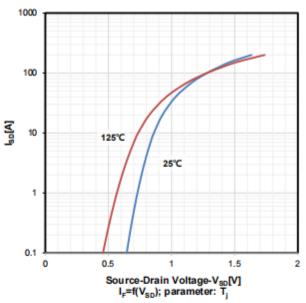
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Drain current vs temperature

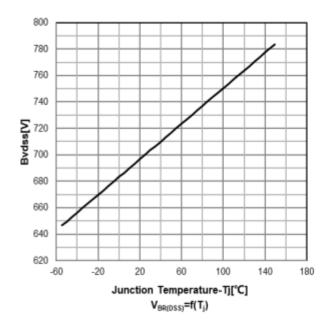
Forward characteristics of reverse diode

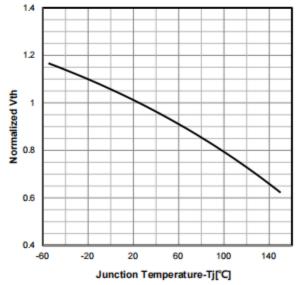




Drain-source breakdown voltage

Normalized $V_{\text{GS}(\text{th})}$ characteristics

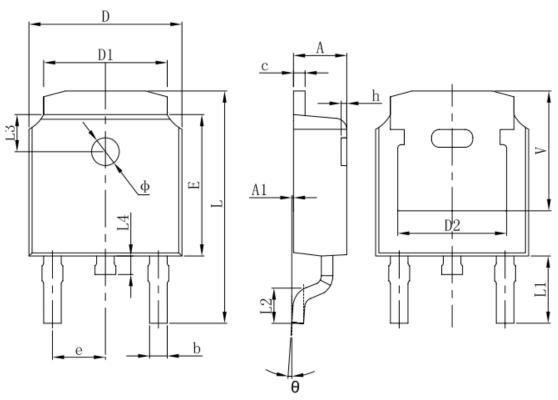




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TO252 Package Information



Cumb al	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.635	0.770	0.025	0.030	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	4.830 REF.		REF.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.712	10.312	0.382	0.406	
L1	2.900 REF.		0.114 REF.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 REF.		0.063 REF.		
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.250	REF.	0.207	REF.	

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